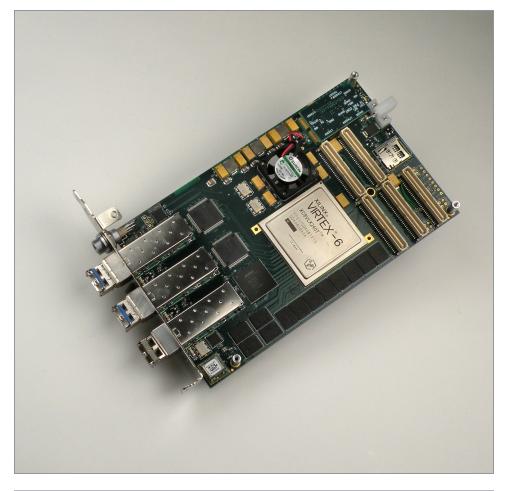


Three-port interface for up to 10GbE / 0C192 (STM64) / 0TU2f



Features

Mezzanine board – pairs with an EDT main board (PCIe), which adds DMA, programmable FPGA resources, and memory

Port 0: One optional SFP+ for 10GbE (optical), OC192 (STM64), or OTU2/2e/2f at 1550 or 1310 nm (or 10GbE at 850 nm)

Port 1: One optional SFP for 1GbE (electrical or optical), OC3/12/48 (STM1/4/16), or OTU1 at 1550, 1310, or 850 nm

Port 2: Identical to (but independent of) port 1

Data processing: SDDS (optional)

FPGA: One programmable Xilinx Virtex 6 (XC6VLX240T, LX365T, SX315T, or SX475T)

DRAM (DDR2): Three independent 512 MB blocks (or combine two for 1 GB)

SERDES: Port 0 = 10G LIU or FPGA MGT; port 1 = SONET/SDH LIU or FPGA MGT; port 2 = SONET/SDH LIU or FPGA MGT

EDT intellectual property for 10GbE PCS and PMA layer, SONET/SDH framing, demultiplexing, and G.709 framing

Time code input: 1 pps or IRIG-B, with user-configurable output

Description

The 3P is a three-port mezzanine board that pairs with a PCIe main board to provide three independent ports, each supporting one optional transceiver. Port 0 supports an SFP+ for 10GbE (optical), OC192 (STM64), or OTU2/2e/2f; ports 1 and 2 each support an SFP for 1GbE (electrical or optical), OC3/12/48 (STM1/4/16), or OTU1. SDDS data processing is available as an option.

The user-configurable FPGA (Xilinx Virtex 6) can access three independent 512 MB blocks of DDR2 DRAM, which can be used as data buffers. Two of these can be combined to create a memory block of 1GB.

Each port links to a SERDES via a specialized LIU or, optionally, via a multigigabit transceiver (MGT) in the FPGA. Each port has its own reference clock, programmable from 10 to 210 MHz. A time code input (1 pps or IRIG-B) also is included.

EDT provides FPGA configuration files to support 1GbE and 10GbE at the PHY layer; OC3/12/48/192 (raw, framed, framed and descrambled, header, and payload); OTU1/2/2e/2f (raw, framed, framed and descrambled); and demultiplexing. Custom files can be requested.

The main board supplies DMA, plus additional memory and programmable FPGA resources.

Applications

Telecommunications monitoring, recording, and processing

SONET/SDH to ethernet conversion

SDDS data processing

Multiple other network processing applications

3P

Product Type	Three-port interface for signals up to 10GbE, 0C192 (STM64), or 0TU2f; it requires an EDT PCIe main board.					
FPGA Resources	One programmable FPGA (Xilinx Virtex 6 XC6VLX240T, LX365T, SX315T, or SX475T), plus FPGA resources on main board					
Memory	DRAM (DDR2) for snapshot recording / data buffering Three independent 32-bit wide 512 MB blocks; two can be combined into a 64-bit wide 1 GB block					
Clocks	Three (reference) — one per port — independently programmable from 10 to 210 MHz; port 0 has additional jitter attenuation.					
Data Rates	Dependent on such factors as data format, main board, and system variables.					
Data Format (1/0)	Port 0 Port 1 Port 2 Also provided is a time con	Ethernet 10GbE (10G BASE-R) 1GbE (1000 BASE-T or -X) 1GbE (1000 BASE-T or -X) de input (to connect to an ext	SONET (SDH) 0C192 (STM64) 0C3/12/48 (STM1/4/16) 0C3/12/48 (STM1/4/16) rernal source) for 1 pps, IRIG	ITU-T G.709 OTU2/2e/2f) OTU1 OTU1 -B, or other input, with user-c	configurable output.	
Data processing	SDDS (optional) is available; with this option, ports 1 and 2 SERDES should be configured for MGT.					
SERDES	The FPGA MGT is capable of line rates of 750 Mb/s to 6.6 Gb/s - or, with 5x digital over sampling, 150 Mb/s to 750 Mb/s. Port 0 10G LIU or optional MGT Port 1 SDH LIU or optional MGT Port 2 SDH LIU or optional MGT) Mb/s.	
PORT 0 (1 SFP+, o Output pow	Three (an optional SFP+ on port 0, and optional SFPs on ports 1 and 2) are available, supporting data as shown below.					
	PORT O (1 SFP+, optional)	ELECTRICAL	OPTICAL 10GbE, 0C192 <u>(STM64), 0TU2/2e/2f</u>	10GbE, 0C192 (STM64), 0TU2/2e/2f	10GbE only	
			1550 nm	1310 nm	850 nm	
	Output power	-	0 to +4 dBm	-8.2 to 0.5 dBm	-5 to -1 dBm	
	Center wavelength	-	1530 to 1565 nm	1260 to 1355 nm	840 to 860 nm	
	Sensitivity Maximum input power	_	23 dBm -7 dBm	-10.3 dBm 0.5 dBm	-7.5 dBm 0.5 dBm	
C P (1) O C S M	Connector	_	LC	LC	LC	
	PORTS 1 and 2 (1 SED each antional)	1065	1GbE, 0C3/12/48	1GbE, 0C3/12/48	1GbE, 0C3/12/48	
	<u>(1 SFP each, optional)</u>	<u>1GbE</u>	<u>(STM1/4/16), OTU1</u> 1550 nm	<u>(STM1/4/16), OTU1</u> 1310 nm	<u>(STM1/4/16), OTU</u> 850 nm	
	Output power	_	-2 to 3 dBm	-9.5 to -3 dBm	-9 to -2.5 dBm	
	Center wavelength	-	1500 to 1580 nm	1270 to 1360 nm	830 to 860 nm	
	Sensitivity	-	-28 dBm	-18 dBm	-18 dBm	
	Maximum input power	-	-9 dBm	0 dBm	0 dBm	
	Connector	RJ45	LC	LC	LC	
Connectors	One RJ45 or LC on each transceiver (as shown above), plus one 7-pin Lemo for time code input					
Cabling	To 7-pin Lemo on board, from time code source, via one DB9 (for 1 pps or IRIG-B) or BNC (for IRIG-B only); for other cabling, consult EDT					
Physical	Weight / DimensionsTBD / 6.6 x 4.2 x 0.75 in. (with a main board)					
Environmental	Temperature (operating / Humidity (operating / non		0° to 40° C / -40° to 70° C 1% to 90%, non-condensing at 40° C / 95%, non-condensing at 45° C			
System and Software	For details on system requirements and EDT-provided software driver packages, see specifications for your EDT main board.					

Ordering Options

- Main board: PCIe8 LX / FX / SX

Specifications

- FPGA: XC6VLX240T / LX365T / SX315T / SX475T
- Data processing: SDDS / no SDDS
- SERDES: [options above]
- Transceivers: 0 / 1 / 2 / 3 [options above]

- Cabling (for time code input): DB9 / BNC Bold is default. For more options, see main board detail. Ask about custom options. **Parhelia B.V.** www.parhelia-bv.com (1)+31(0)10 741 00 28



